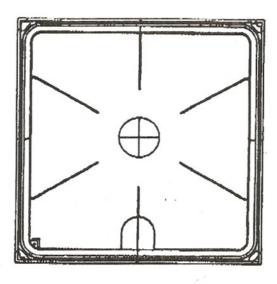


## Sierra Components, Inc.

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Chip back potential is the level which bulk silicon is maintained by on-chip connection, or it is the level to which the chip back must be connected when specifically stated below. If no potential is given the chip back should be isolated.



IE SIZE: 240 x 240 mile

OURCE ATTACH AREA 40 mll Diameter

GATE ATTACH AREA 32 x 32 mils

BACK SIDE DRAIN

Topside Metal: -

Backside: -

Backside Potential: -

Mask Ref: -

Bond Pads: -

APPROVED BY: CD

MFG: Harris

DIE SIZE: .240" x .240"

THICKNESS: -

DATE: 7/25/02

P/N: FRC450R

DG 10.1.2 Rev A 3-4-99